## **TERMINATION CHIP 150 WATT**



**DATA SHEET PART SERIES: 82-3006**  SHEET 1 OF 2 Dwg 82-3006

EN 13-3453

### **FEATURES**

## **APPLICATIONS**

Mobile Networks Wide Band Operation High Power Broadcast

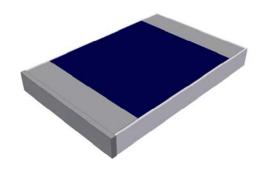
**Direct Attached High Power Amplifiers** 

Low VSWR Isolators Easy Installation Military

Instrumentation



EMC Technology offers the widest selection of chip terminations worldwide. Chip components are offered in both thick and thin film resistive material and available in Alumina, Aluminum Nitride, Beryllium Oxide and CVD Diamond.



### ORDERING INFORMATION

Part Identifier: 82-3006

## **SPECIFICATIONS**

## 1.0 ELECTRICAL

50 ohms Nominal Impedance: Frequency Range: DC - 1.0 GHz

VSWR: DC-0.5 GHz 1.20:1 Max

0.5-1.0 GHz 1.35:1 Max

Input Power CW: 150 Watts @ 100°C heat sink, derated linearly to zero power and 150°C

1500 Watts (based on 10us pulse width and 1% duty cycle) Peak Power:

DC Resistance: 50 Ω ±5%

#### 2.0 ENVIRONMENTAL

Operating Temperature: -55°C to +150°C Non-operating Temperature: -65°C to +150°C Temperature Coefficient: +/-200 PPM / °C max

3.0 MARKING

Unit Marking: No Marking

4.0 QUALITY ASSURANCE

Visual and Mechanical Inspection: Per 824W107

DC Resistance Check: 100% DC Resistance Check

Data Retention: Standard

5.0 PACKAGING

Standard Packaging: Tape and Reel

smiths microwave Form 423F103 Rev-

Cage Codes: 24602 / 2Y194 Specifications are Subject to Change Without Notice

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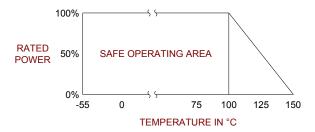
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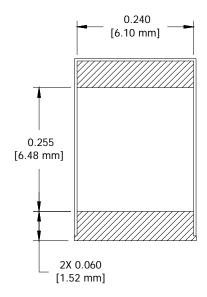
### **6.0 MECHANICAL**

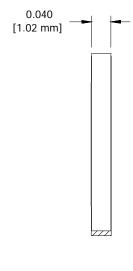
Substrate Material: Beryllium Oxide

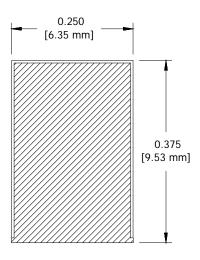
Thin Film Resistive Film: Terminal Material: Tin/Lead

Metric Dimensions: Provided for reference only









Unless Otherwise Specified: TOLERANCE:  $X.XX = \pm 0.02$   $X.XXX = \pm 0.010$